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NCS36510 - Low Power System-on-Chip For 2.4 GHz IEEE ...Down To About 1.1 V. From 2 V To 2.6 V The Pre-regulator Uses An Internal Linear Regulator To Generate V1V. From 2.6 V To 3.6 V An Internal Switching Regulator Can Be Used To Increase The Power Conversion Efficiency. In 1 V Mode The Pre-regulator Is Disabled And The Core Is Supplied Directly. V1V Can Be As Low As Jan 5th, 2024
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Abstract This Paper Presents A On-chip Stack Based Memory Or-organization That Effectively Reduces The Energy Dissipation In Programmable Embedded System Architectures. Most Em-bedded Systems Use Feb 11th, 2024
WW25R ±±1%, ±±5%, 2W Metal Plate Low Ohm Power Chip ...Page 2 Of 7 ASC_WW25R_V07 Apr.-2013
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